

Docket No.: ROH -0031/DIV
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Divisional Patent Application of U.S.
Application No.: 09/704,563
Junichi HIKITA, et al.

Application No.: *To Be Assigned*

Group Art Unit: 2823

Filed: July 24, 2003

Examiner: W. Coleman

For: METHOD OF PRODUCING A SEMICONDUCTOR DEVICE BY DIVIDING A
SEMICONDUCTOR WAFER INTO SEPARATE PIECES OF SEMICONDUCTOR
CHIPS (AS AMENDED)

PRELIMINARY AMENDMENT

MAIL STOP PATENT APPLICATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

I. INTRODUCTORY COMMENTS

Prior to examination on the merits, please amend the above-identified U.S. patent application as set forth below.

Claims 6-17 are pending in the application. By this Amendment, claims 1-5 are canceled without prejudice or disclaimer.